SN74ALS156 DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPUTS SDAS099C – JUNE 1986 – REVISED MAY 1996

| | plications: Dual 2-Line to 4-Line Decoder | D OR N P (TOP) | |
|----------|--|--|--------------------------|
| | Dual 1-Line to 4-Line Demultiplexer | | <u>רר</u> |
| | 3-Line to 8-Line Decoder I-Line to 8-Line Demultiplexer | 1 <u>C</u> <u> </u> 1 1 <u>G</u> <u> </u> 2 | 16 V <u>C</u> C 15 2C |
| | lividual Strobes Simplify Cascading for | B 3 | 14 2G |
| | coding or Demultiplexing Larger Words | 1Y3 🛛 4 | 13 A |
| | ckage Options Include Plastic | 1Y2 5 | 12 2Y3 |
| Sm | all-Outline (D) Packages and Standard | 1Y1 [] 6 1Y0 [] 7 | 11 2Y2 10 2Y1 |
| Pla | stic (N) 300-mil DIPs | GND 8 | 9 2Y0 |
| docarint | ion | | |

description

One of the main applications of the SN74ALS156 is as a dual 1-line to 4-line decoder/demultiplexer with individual strobes (\overline{G}) and common binary-address inputs in a single 16-pin package. When both sections are enabled, the common binary-address inputs sequentially select and route associated input data to the appropriate output of each section. The individual strobes permit enabling or disabling each of the 4-bit sections, as desired.

Data applied to input 1C is inverted at its outputs and data applied at input $2\overline{C}$ is not inverted through its outputs. The inverter following the 1C data input permits use of the SN74ALS156 as a 3-line to 8-line demultiplexer without external gating. All inputs are clamped with high-performance Schottky diodes to suppress line ringing and simplify system design.

The SN74ALS156 is characterized for operation from 0°C to 70°C.



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Function Tables

| | I | NPUTS | | OUTPUTS | | | | | | |
|-----|-----------|------------------|------|---------|-----|-----|-----|--|--|--|
| SEL | SELECT ST | | DATA | | | | | | | |
| В | Α | 1 <mark>G</mark> | 1C | 1Y0 | 1Y1 | 1Y2 | 1Y3 | | | |
| Х | Х | Н | Х | Н | Н | Н | Н | | | |
| L | L | L | Н | L | Н | Н | Н | | | |
| L | Н | L | Н | н | L | Н | Н | | | |
| н | L | L | Н | н | Н | L | Н | | | |
| н | н | L | н | н | н | н | L | | | |
| Х | Х | Х | L | Н | Н | Н | Н | | | |

2-LINE TO 4-LINE DECODER OR 1-LINE TO 4-LINE DEMULTIPLEXER

2-LINE TO 4-LINE DECODER OR **1-LINE TO 4-LINE DEMULTIPLEXER**

| | I | NPUTS | | | | | | | | | | |
|--------|---|------------------|------|---------|-----|-----|-----|--|--|--|--|--|
| SELECT | | STROBE | DATA | OUTPUTS | | | | | | | | |
| В | Α | 2 <mark>G</mark> | 2C | 2Y0 | 2Y1 | 2Y2 | 2Y3 | | | | | |
| Х | Х | Н | Х | Н | Н | Н | Н | | | | | |
| L | L | L | L | L | Н | Н | н | | | | | |
| L | Н | L | L | н | L | Н | н | | | | | |
| н | L | L | L | н | Н | L | н | | | | | |
| н | н | L | L | н | Н | Н | L | | | | | |
| Х | Х | Х | Н | н | Н | Н | Н | | | | | |

3-LINE TO 8-LINE DECODER OR **1-LINE TO 8-LINE DEMULTIPLEXER**

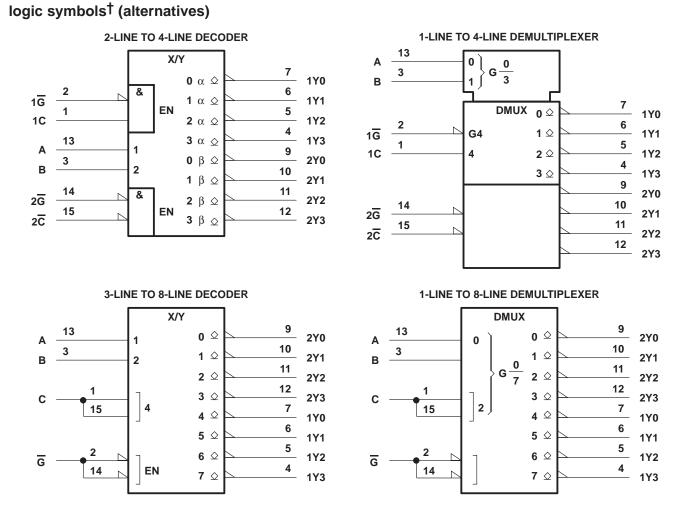
| | IN | PUTS | | | | | OUT | PUTS | | | |
|----|--------|------|--------------|-----|-----|-----|-----|------|-----|-----|-----|
| | SELECT | | STROBE OR | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| c† | В | Α | DATA G‡ | 2Y0 | 2Y1 | 2Y2 | 2Y3 | 1Y0 | 1Y1 | 1Y2 | 1Y3 |
| Х | Х | Х | Н | Н | Н | Н | Н | Н | Н | Н | Н |
| L | L | L | L | L | Н | Н | Н | L | Н | Н | Н |
| L | L | Н | L | Н | L | Н | Н | Н | L | Н | Н |
| L | Н | L | L | Н | Н | L | Н | Н | Н | Н | Н |
| L | Н | Н | L | Н | Н | Н | L | Н | Н | Н | Н |
| н | L | L | L | Н | Н | Н | Н | L | Н | Н | Н |
| н | L | Н | L | Н | Н | Н | Н | Н | L | Н | Н |
| н | Н | L | L | Н | Н | L | Н | Н | Н | L | Н |
| Н | Н | Н | L | Н | Н | Н | L | Н | Н | Н | L |

 $\frac{1}{C} = \text{inputs } 1C \text{ and } 2C \text{ connected together}$ $\frac{1}{G} = \text{inputs } 1G \text{ and } 2G \text{ connected together}$



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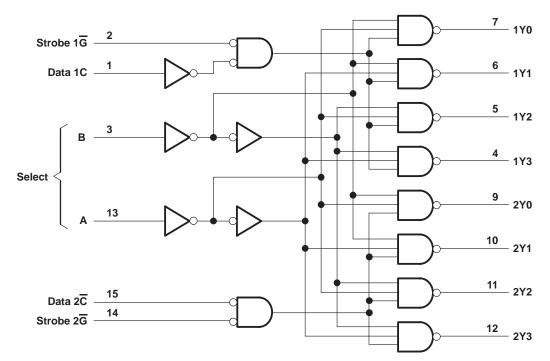
[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



SN74ALS156 DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPUTS

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| Supply voltage, V _{CC} |
|--|
| Input voltage, V ₁ |
| Operating free-air temperature range, T _A |
| Storage temperature range, T _{stg} –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | | MIN | NOM | MAX | UNIT |
|----------|--------------------------------|-----|-----|-----|------|
| VCC | Supply voltage | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | V |
| VOH | High-level output voltage | | | 5.5 | V |
| IOL | Low-level output current | | | 8 | mA |
| TA | Operating free-air temperature | 0 | | 70 | °C |



SN74ALS156 DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPUTS SDAS099C - JUNE 1986 - REVISED MAY 1996

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CO | TEST CONDITIONS | | | | |
|-----------------|--------------------------|-------------------------|------|------|----|--|
| VIK | $V_{CC} = 4.5 V,$ | lj = – 18 mA | | -1.5 | V | |
| N . | V _{CC} = 4.5 V | $I_{OL} = 4 \text{ mA}$ | 0.25 | 0.4 | | |
| VOL | VCC = 4.5 V | I _{OL} = 8 mA | 0.35 | 0.5 | V | |
| IОН | $V_{CC} = 4.5 V,$ | V _{OH} = 5.5 V | | 0.1 | mA | |
| lj | $V_{CC} = 5.5 V,$ | $V_{I} = 7 V$ | | 0.1 | mA | |
| ЧΗ | V _{CC} = 5.5 V, | VI = 2.7 V | | 20 | μA | |
| ١ _{١L} | V _{CC} = 5.5 V, | VI = 0.4 V | | -0.1 | μA | |
| ICCL | V _{CC} = 5.5 V | | 5 | 9 | mA | |

[†] All typical values are at $V_{CC} = 5 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}.$

switching characteristics (see Figure 1)

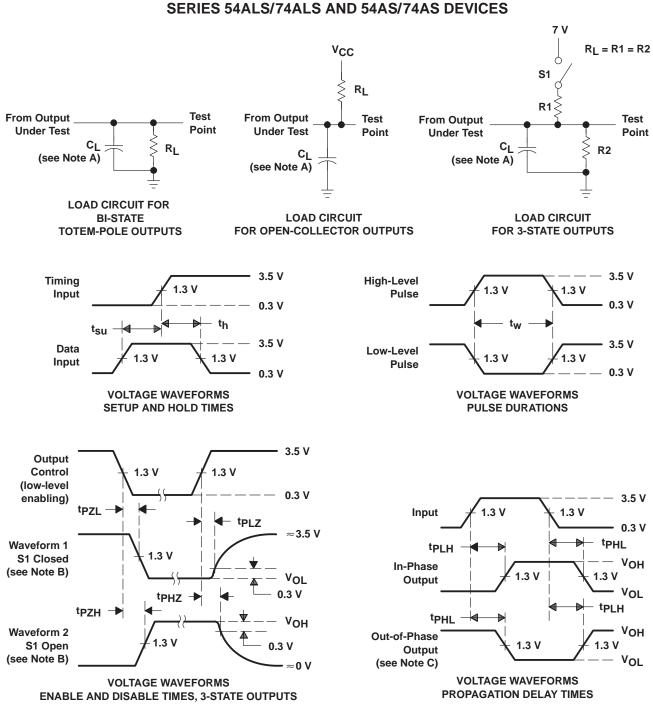
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 4.5$ $C_{L} = 50 \text{ pl}$ $R_{L} = 500 \text{ s}$ $T_{A} = \text{MIN}$ | UNIT | |
|------------------|---------------------------------|----------------|--|------|----|
| | | | MIN | MAX | |
| ^t PLH | | | 7 | 55 | |
| ^t PHL | А, В | 1Y, 2Y | 6 | 25 | ns |
| ^t PLH | 10 | 1Y | 7 | 50 | ns |
| ^t PHL | 1C | 1 Y | 6 | 23 | |
| ^t PLH | 1 <mark>G</mark> | 47 | 7 | 38 | |
| ^t PHL | 1G | 1Y | 6 | 22 | ns |
| ^t PLH | 2 0 , 2 0 | 2Y | 7 | 38 | |
| ^t PHL | 20, 20 | 21 | 6 | 22 | ns |

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SN74ALS156 DECODER/DEMULTIPLEXER WITH OPEN-COLLECTOR OUTPUTS

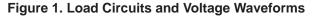
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PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- C. When measuring propagation delay items of 3-state outputs, switch S its open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.







PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan | Lead finish/ | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|---------|--------------|---------|------|---------|--------------|---------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | Ball material | (3) | | (4/5) | |
| | | | | | | | (6) | | | | |
| SN74ALS156D | LIFEBUY | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS156 | |
| SN74ALS156DE4 | LIFEBUY | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS156 | |
| SN74ALS156DR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS156 | Samples |
| SN74ALS156DRE4 | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | ALS156 | Samples |
| SN74ALS156N | ACTIVE | PDIP | Ν | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN74ALS156N | Samples |

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures. "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL. Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



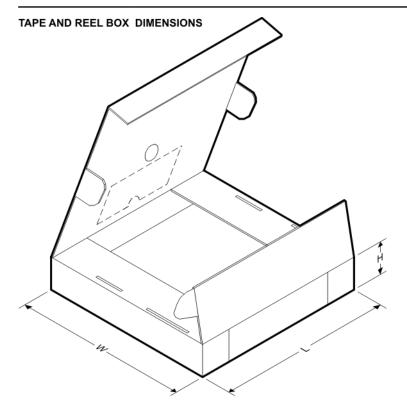
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74ALS156DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |



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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ALS156DR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |



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TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ALS156D | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74ALS156DE4 | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74ALS156N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74ALS156N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



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